Product data sheet

1. General description

Ultrafast, dual common cathode, epitaxial rectifier diodes in a SOT428 (DPAK) plastic package.

2. Features and benefits

- Fast switching
- Low thermal resistance
- · Soft recovery characteristic
- Low forward voltage drop
- Reverse surge capability
- · High thermal cycling performance

3. Applications

· Output rectifiers in high-frequency switched-mode power supplies

4. Quick reference data

Table 1. Quick reference data

	uick reference data	O PRO CO		1//			11.34
Symbol				Values			Unit
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage		200				V
I _{O(AV)}	average output current	$δ$ = 0.5; square-wave pulse; $T_{mb} \le 119$ °C; both diodes conducting; Fig. 5; Fig. 6		1	10		Α
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 119 °C; square-wave pulse; per diode	10		Α		
I _{FSM} non-repetitive peak forward current		t _p = 10 ms; sine-wave pulse; per diode	50		Α		
		t_p = 8.3 ms; sine-wave pulse; per diode	55			Α	
Symbol	Parameter	Conditions	Min Typ Max		Max	Unit	
Static ch	aracteristics						
V_{F}	forward voltage	I _F = 5 A; T _j = 25 °C; <u>Fig. 2</u>		-	0.95	1.1	V
		I _F = 5 A; T _j = 150 °C; <u>Fig. 2</u>		-	8.0	0.895	V
		I _F = 10 A; T _j = 25 °C; <u>Fig. 2</u>		-	1.1	1.25	V
Dynamic	characteristics				,		
t _{rr}	reverse recovery time	ramp recovery; $I_F = 1 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 100 \text{ A}/\mu\text{s}$; $T_j = 25 ^{\circ}\text{C}$; Fig. 3		-	15	25	ns
		step recovery; when switched from $I_F = 0.5 \text{ A to } I_R = 1 \text{ A}$; measured at $I_R = 0.25 \text{ A}$		-	10	20	ns

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode 1		
2	K	cathode [1]		
3	A2	anode 2		A1 D A2
mb	К	mounting base; connected to cathode		K sym125

[1] It is not possible to connect to pin 2 of the SOT428 package.

6. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BYQ28ED-200	DPAK	plastic single-ended surface-mounted package (DPAK); 3-leads (one lead cropped)	SOT428		

7. Marking

Table 4. Marking codes

Type number	Marking codes
BYQ28ED-200	BYQ28ED-200

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		200	V
V_{RWM}	crest working reverse voltage		200	V
V_R	reverse voltage	δ = 1.0; square-wave pulse;	200	V
I _{O(AV)}	average output current	δ = 0.5; square-wave pulse; T _{mb} ≤ 119 °C; both diodes conducting; <u>Fig. 5</u> ; <u>Fig. 6</u>	10	А
I _{FRM}	repetitive peak forward current	$δ = 0.5$; $t_p = 25 \mu s$; $T_{mb} \le 119 °C$; square-wave pulse; per diode	10	А
I _{FSM}	non-repetitive peak	t_p = 10 ms; sine-wave pulse; per diode	50	Α
	forward current	t_p = 8.3 ms; sine-wave pulse; per diode	55	А
I _{RM}	peak reverse recovery current	$\delta = 0.001$; $t_p = 2 \mu s$	0.2	Α
I _{RSM}	non-repetitive peak reverse current	t _p = 100 μs	0.2	А
T _{stg}	storage temperature		-40 to 150	°C
T _j	junction temperature		150	°C
Electrosta	tic discharge		1	1
V _{ESD}	electrostatic discharge voltage	all pins; human body model; C = 250 pF; R = 1.5 k Ω	8	kV

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to	with heatsink compound; both diodes conducting	-	-	3	K/W
n	mounting base	with heatsink compound; per diode; Fig 1	-	-	4.5	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	60	-	K/W

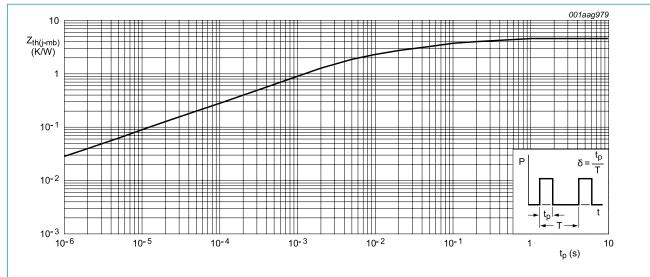
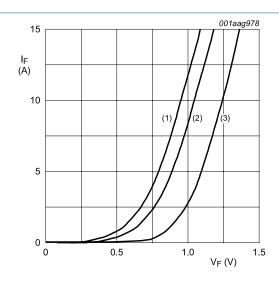


Fig. 1. Transient thermal impedance from junction to mounting base as a function of pulse width

10. Characteristics

Table 7. Characteristics

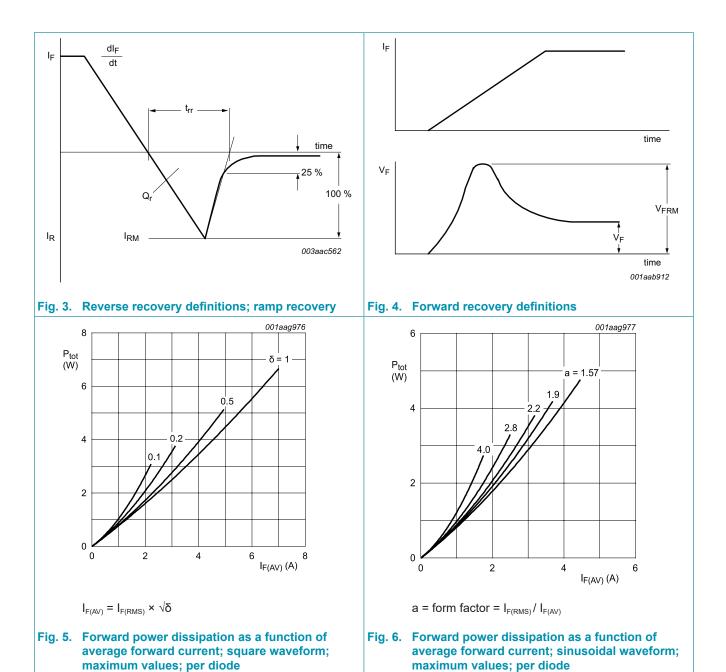
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V_{F}	forward voltage	I _F = 5 A; T _j = 150 °C; <u>Fig. 2</u>	-	0.8	0.895	V
		I _F = 5 A; T _j = 25 °C; <u>Fig. 2</u>	-	0.95	1.1	V
		I _F = 10 A; T _j = 25 °C; <u>Fig. 2</u>	-	1.1	1.25	V
I_R	reverse current	$V_R = 200 \text{ V}; T_j = 25 ^{\circ}\text{C}$	-	2	10	μA
		V _R = 200 V; T _j = 100 °C	-	0.1	0.2	mA
Dynamic	characteristics					
Q_r	recovered charge	$I_F = 2 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 20 \text{ A/}\mu\text{s}$; $T_j = 25 \text{ °C}$; Fig. 3	-	4	9	nC
t _{rr}	reverse recovery time	ramp recovery; $I_F = 1 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 100 \text{ A}/\mu\text{s}$; $T_j = 25 \text{ °C}$; Fig. 3	-	15	25	ns
		step recovery; when switched from $I_F = 0.5 \text{ A to } I_R = 1 \text{ A}$; measured at $I_R = 0.25 \text{ A}$	-	10	20	ns
I _{RM}	peak reverse recovery current	$I_F = 5 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 50 \text{ A/}\mu\text{s}$; $T_j = 25 \text{ °C}$; Fig. 3	-	0.5	0.7	А
V_{FR}	forward recovery voltage	$I_F = 1 \text{ A}; \text{ d}I_F/\text{d}t = 10 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 4$	-	1	-	V



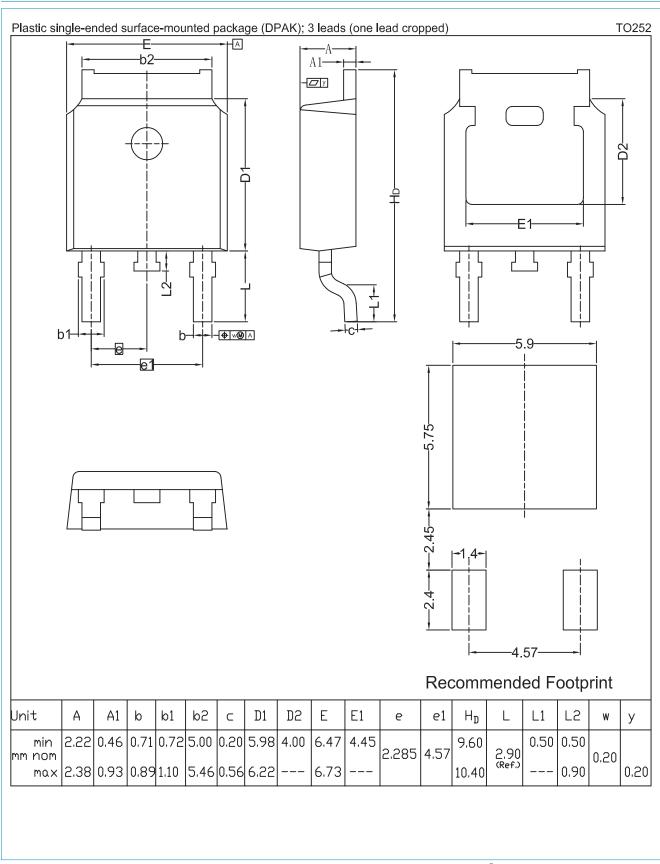
(1) T_j = 150 °C; typical values (2) T_j = 150 °C; maximum values

(3) T_i = 25 °C; maximum values

Fig. 2. Forward current as a function of forward voltage



11. Package outline



12. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
BYQ28ED-200 v.5	20180224	Product data sheet	-	BYQ28_SER_E_ED_4			
Modifications: Change from NXP version to WeEn version							
BYQ28_SER_E_ED_4	20071205	Product data sheet	-	BYQ28E_SERIES_3			
 • The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. • Legal texts have been adapted to the new company name where appropriate. • Limiting values table: some parameter descriptions amended to conform to latest standards; IFRM conditions amended; VESD row added. • Characteristics: Qrr changed to Qr 'recovered charge'; trr1 and trr2 changed to trr with 'ramp recovery' and 'step recovery' added to conditions. 							
BYQ28E_SERIES_3	19981001	Product specification	-	BYQ28E_SERIES_2			
BYQ28E_SERIES_2	19980701	Product specification	-	BYQ28E_SERIES_1; BYQ28EB_SERIES_1			
BYQ28E_SERIES_1; BYQ28EB_SERIES_1	19960801	Product specification	-	-			

13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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Product data sheet

WeEn Semiconductors

BYQ28ED-200

Rectifier diodes ultrafast, rugged

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